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N-Channel SuperFET[®] II MOSFET 800 V, 2.6 A, 2.25 Ω

Features

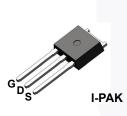
- R_{DS(on)} = 1.87 Ω (Typ.)
- Ultra Low Gate Charge (Typ. Q_g = 11 nC)
- Low E_{oss} (Typ. 1.1 uJ @ 400V)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 51 pF)
- 100% Avalanche Tested
- RoHS Complian
- ESD Improved Capability

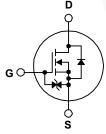
Applications

- AC DC Power Supply
- LED Lighting

Description

SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as Audio, Laptop adapter, Linghting, ATX power and industrial power applications.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		FCU2250N80Z	Unit V			
V _{DSS}	Drain to Source Voltage	800				
V _{GSS}	Cata ta Causa Maltana	- DC		±20		
	Gate to Source Voltage	- AC	±30	V		
ID	Desia Current	- Continuous (T _C = 25 ^o C)	2.6	A		
	Drain Current	- Continuous ($T_C = 100^{\circ}C$)	1.7			
I _{DM}	Drain Current	- Pulsed	(Note 1)	6.5	Α	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			21.6	mJ	
I _{AR}	Avalanche Current (Note 1)			0.52	Α	
E _{AR}	Repetitive Avalanche Energy (Note 1)			0.39	mJ	
dv/dt	MOSFET dv/dt			100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)			20		
P _D	Devues Dissinction	$(T_{\rm C} = 25^{\rm o}{\rm C})$		39	W	
	Power Dissipation	- Derate Above 25°C		0.31	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

Thermal Characteristics

Symbol	Parameter	FCU2250N80Z	Unit		
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	Il Resistance, Junction to Case, Max. 3.2			
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	100	°C/W		

January 2015

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Part N	Part Number Top Mark		Package	Packing Method Reel Size		Tape Width		Quantity	
· · · · · · · · · · · · · · · · · · ·		IPAK			N/A		75 units		
Electric	al Chai	racteristics ⊤ _c =	25ºC unless	otherwise noted.				-	
Symbol		Parameter		Test Conditions		Min.	Тур.	Max.	Unit
Off Chara	acteristic	s							
BV _{DSS}	Drain to Source Breakdown Voltage		V _{GS} = 0 V, I _D = 1 mA, T _J = 25°C		800	-	-	V	
∆BV _{DSS}		Breakdown Voltage Temperature Coefficient		$I_D = 1$ mA, Referenced to 25°C			0.95		V/ºC
$/\Delta T_J$	Coeffic					-	0.85	-	V/°C
I _{DSS}	Zero G	Zero Gate Voltage Drain Current		$\frac{V_{DS} = 800 \text{ V}, V_{GS} = 0 \text{ V}}{V_{DS} = 640 \text{ V}, V_{GS} = 0 \text{ V}, T_C = 125^{\circ}\text{C}}$		-	-	25	μA
USS	Zero Gale voltage Drain Current		,110			-	- 25	250) μΑ
I _{GSS}	Gate to	Body Leakage Current	t	V_{GS} = ±20 V, V_{DS} = 0 V		-	-	±10	μA
On Chara	cteristic	S							
V _{GS(th)}		hreshold Voltage		$V_{GS} = V_{DS}, I_{D} = 0.26$	mA	2.5	-	4.5	V
R _{DS(on)}		Drain to Source On Res	istance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 1.3 \text{ A}$		-	1.87	2.25	Ω
9FS	Forwar	d Transconductance		$V_{\rm DS} = 20 \text{ V}, \text{ I}_{\rm D} = 1.3 \text{ A}$		-	2.28	-	S
Dynamic	Charact	eristics							
C _{iss}	Input C	Input Capacitance		V 400 V V 0 V		-	440	585	pF
C _{oss}	Output	Capacitance		V _{DS} = 100 V, V _{GS} = 0 V, f = 1 MHz		-	16	22	pF
C _{rss}	Revers	e Transfer Capacitance	;			-	0.75	-	pF
C _{oss}	Output	Output Capacitance		V_{DS} = 480 V, V_{GS} = 0 V, f = 1 MHz		-	8.4	-	pF
C _{oss(eff.)}	Effectiv	Effective Output Capacitance		$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$		-	51	-	pF
Q _{g(tot)}	Total G	ate Charge at 10V		V _{DS} = 640 V, I _D = 2.6 A, V _{GS} = 10 V		-	11	14	nC
Q _{gs}	Gate to	Source Gate Charge				-	2.2	-	nC
Q _{gd}	Gate to	Drain "Miller" Charge			(Note 4)	-	4.3	-	nC
ESR	Equiva	lent Series Resistance		f = 1 MHz		-	2.8	-	Ω
Switching	g Charac	teristics							
t _{d(on)}	Turn-O	n Delay Time				-	11	32	ns
t _r	Turn-O	n Rise Time		V_{DD} = 400 V, I _D = 2.6 A, V_{GS} = 10 V, R _g = 4.7 Ω (Note 4)		-	6.7	23	ns
t _{d(off)}	Turn-O	ff Delay Time					26	62	ns
t _f	Turn-O	ff Fall Time				-	8.7	27	ns
	urce Dio	de Characteristic	s			7			_
I _S	Maximum Continuous Drain to Source Diode Forward Current				-	-	2.6	А	
I _{SM}	Maximum Pulsed Drain to Source Diode Fo					-	-	6.5	A
V _{SD}				$V_{GS} = 0 V, I_{SD} = 2.6 A$	A	-	_	1.2	V
t _{rr}		e Recovery Time	30	$V_{GS} = 0 V, I_{SD} = 2.6 A,$ $V_{GS} = 0 V, I_{SD} = 2.6 A,$ $dI_F/dt = 100 A/\mu s$		-	260	-	ns
Q _{rr}		e Recovery Charge				_	2.2		μC

 $\begin{aligned} &2.\ I_{AS} = 0.52\ A,\ R_G = 25\ \Omega,\ starting\ T_J = 25^\circ C. \\ &3.\ I_{SD} \leq 2.6\ A,\ di/dt \leq 200\ A/\mu s,\ V_{DD} \leq BV_{DSS},\ starting\ T_J = 25^\circ C. \end{aligned}$

Essentially independent of operating temperature typical characteristics.

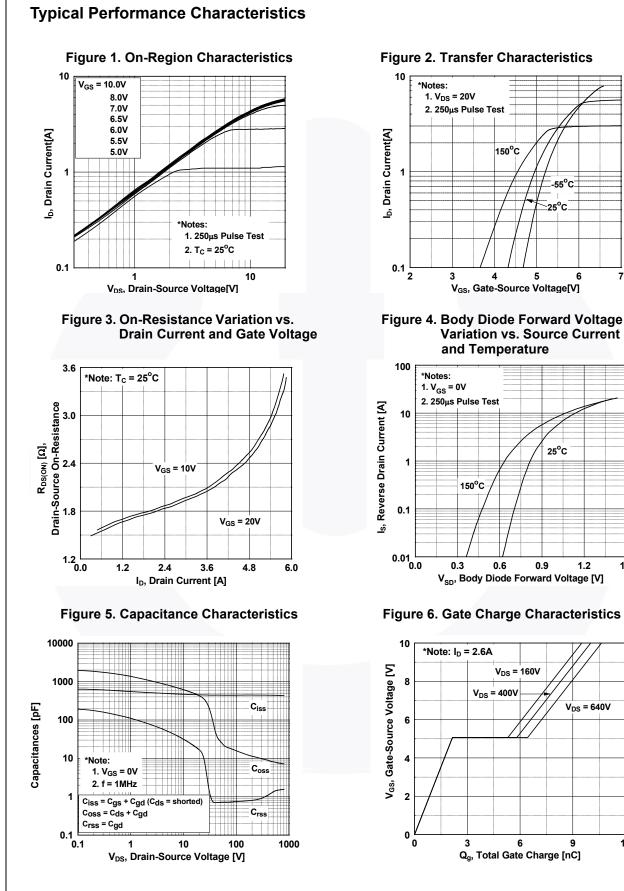


Figure 2. Transfer Characteristics

150°C

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-55°C 25°C

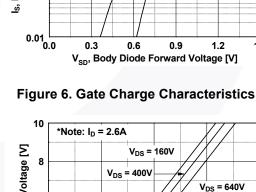
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7

1.5

5

25°C



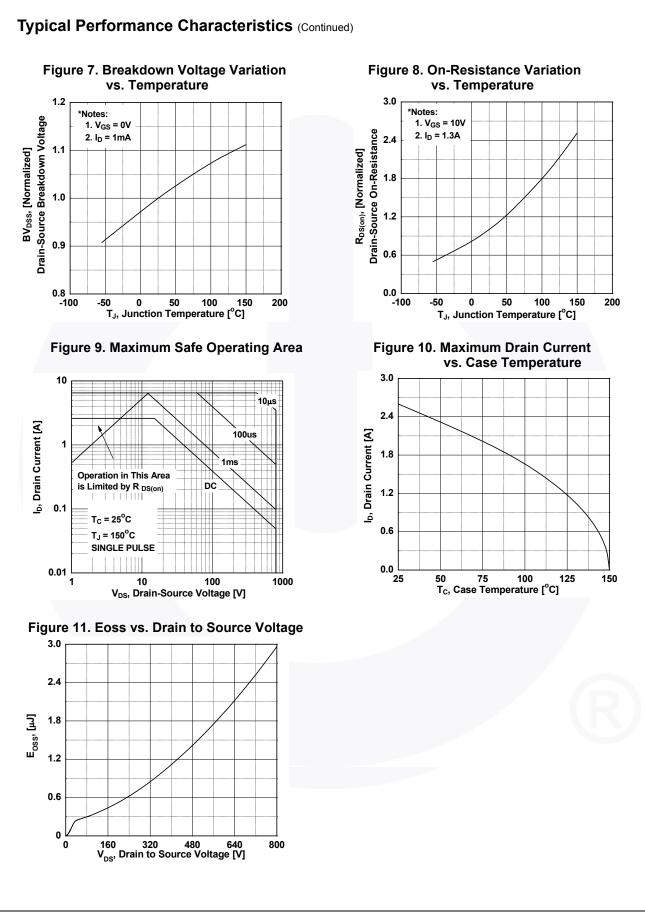
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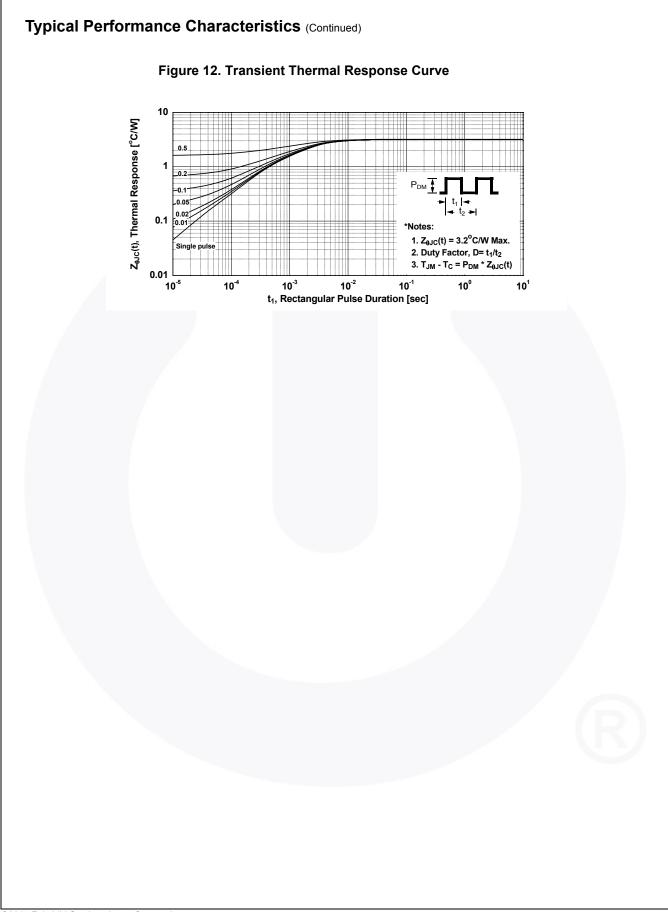
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FCU2250N80Z — N-Channel SuperFET[®] II MOSFET

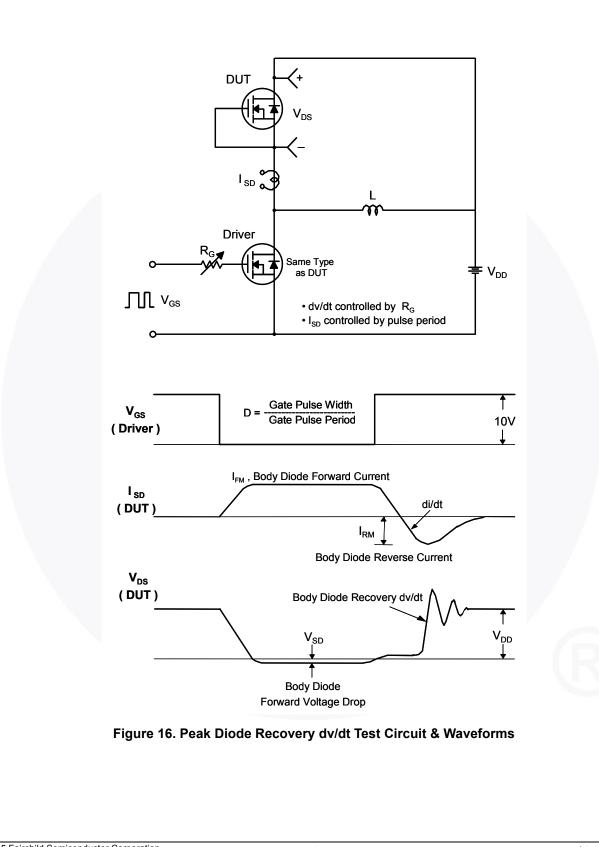


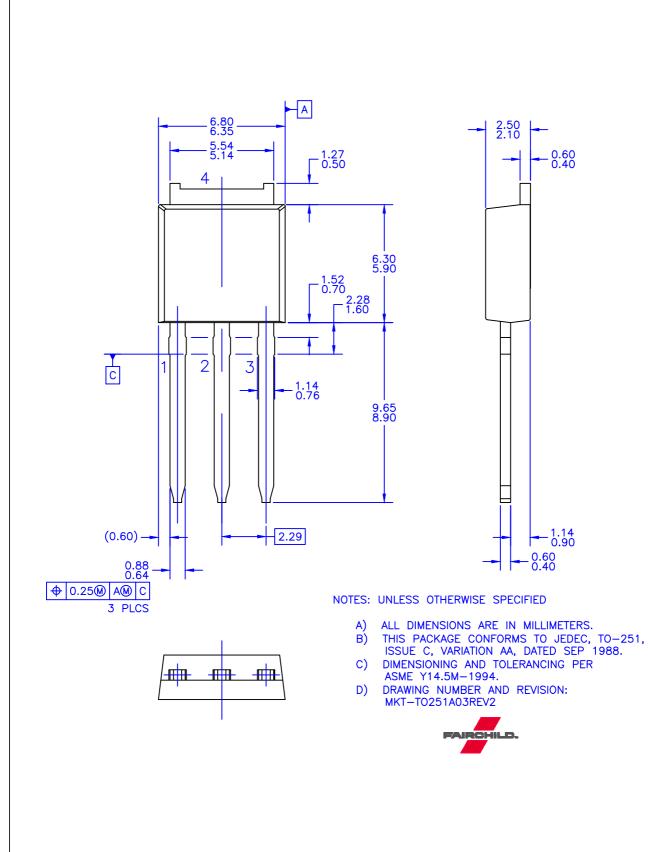


 V_{GS} ק∠ Qg 10V ≑v∝ V_{GS} Q_{gd} a Η DUT 1mA Charge Figure 13. Gate Charge Test Circuit & Waveform R_{L} V_{DS} V_{DS}) 90% VDD Ycs Rg 10 % V_{GS} DUT 10V Л Figure 14. Resistive Switching Test Circuit & Waveforms L $E_{AS} = -\frac{1}{2} L I_{AS}^2$ Vos BV_{DSS} п I_{AS} Rg ⇒∨m $I_{D}(t)$ VDD DUT 10V V_{DS} (t) Time Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

FCU2250N80Z — N-Channel SuperFET[®] II MOSFET

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